

2.0x1.25mm SMD CHIP LED LAMP

APTK2012MGC

MEGA GREEN

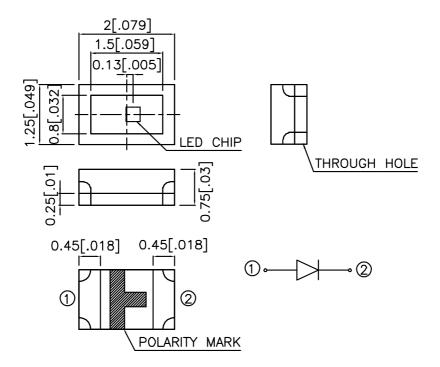
Features

- •2.0mmx1.25mm SMT LED, 0.75mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACK LIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE:2000PCS/REEL

Description

The Mega Green source color devices are made with DH InGaAIP on GaAs substrate Light Emitting Diode.

Package Dimensions



Notes

- All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1 (0.004")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

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 REV NO: V.2
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 APPROVED: J. Lu
 CHECKED: Allen Liu
 DRAWN: W.J.ZHU
 ERP:1204000313

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Selection Guide

Part No.	Dice	Lens Type	lv (m @ 20	,	Viewing Angle
			Min.	Тур.	201/2
APTK2012MGC	MEGA GREEN (InGaAIP)	WATER CLEAR	36	80	100°

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Mega Green	574		nm	IF=20mA
λD	Dominate Wavelength	Mega Green	568		nm	I==20mA
Δλ1/2	Spectral Line Half-width	Mega Green	26		nm	IF=20mA
С	Capacitance	Mega Green	20		pF	VF=0V;f=1MHz
VF	Forward Voltage	Mega Green	2.1	2.5	V	IF=20mA
lR	Reverse Current	Mega Green		10	uA	VR = 5V

Absolute Maximum Ratings at Ta=25°C

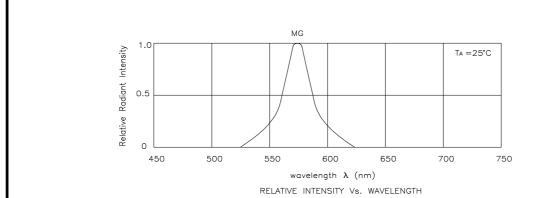
Parameter	Mega Green	Units	
Power dissipation	105	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating/Storage Temperature	-40°C To +85°C		

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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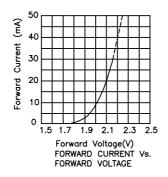
Note: 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

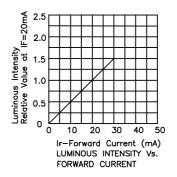
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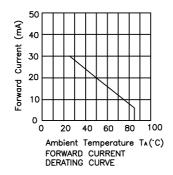


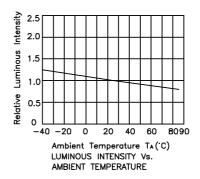
Mega Green

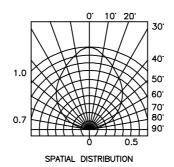
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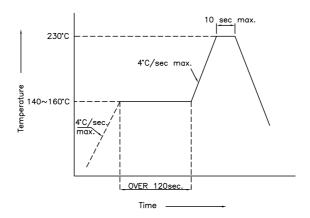
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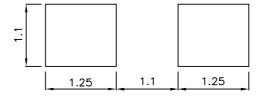
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SMT Reflow Soldering Instructions

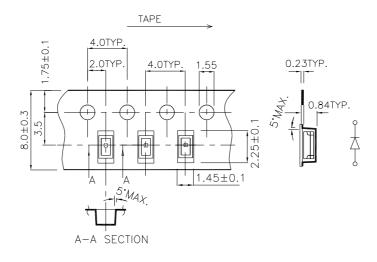
Number of reflow process shall be 2 times or less and cooling process to normal temperature is required between first and second soldering process.



Recommended Soldering Pattern (Units: mm)



Tape Specifications (Units: mm)



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